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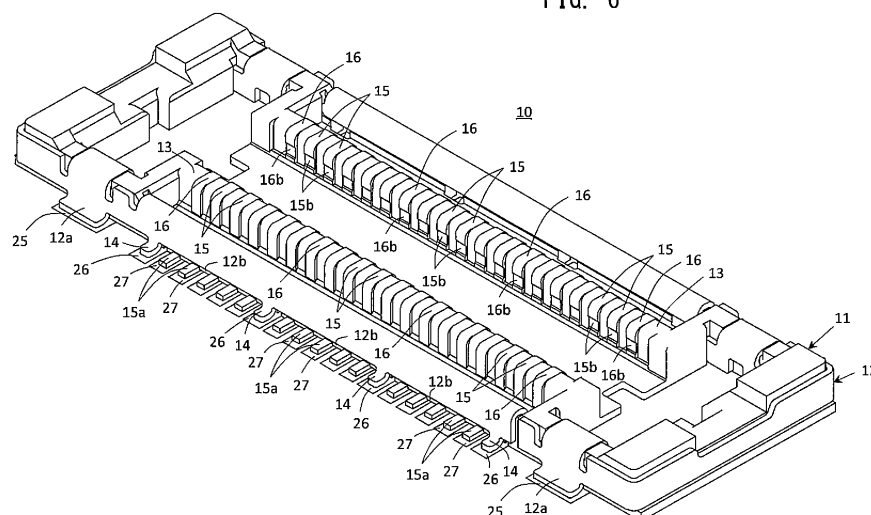
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(54) **Electrical connector for use with a circuit board**

(57) An electrical connector for use with a circuit board including an insulating housing (11) used to be fixed to a circuit board, a plurality of signal contacts (15) arranged on the insulating housing (11) along a longitudinal direction of the same, at least one ground contact (16) provided in an arrangement of the signal contacts (15) on the insulating housing (11), and a conductive shell member (12) provided for covering partially a portion of the insulating housing (11) and to be connected with a

grounding portion (25) of the circuit board, wherein the conductive shell member (12) has a ground connecting reed-like portion (14) formed thereon so as to correspond to the ground contact (16) and both of the ground connecting reed-like portion (14) of the conductive shell member (12) and the ground contact (16) are connected by means of soldering with the grounding portion (25) of the circuit board.

FIG. 6





EUROPEAN SEARCH REPORT

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			TECHNICAL FIELDS SEARCHED (IPC)
			H01R
The present search report has been drawn up for all claims			
Place of search The Hague		Date of completion of the search 19 August 2014	Examiner Stichauer, Libor
CATEGORY OF CITED DOCUMENTS X : particularly relevant if taken alone Y : particularly relevant if combined with another document of the same category A : technological background O : non-written disclosure P : intermediate document T : theory or principle underlying the invention E : earlier patent document, but published on, or after the filing date D : document cited in the application L : document cited for other reasons & : member of the same patent family, corresponding document			

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**ANNEX TO THE EUROPEAN SEARCH REPORT
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